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Sector # 34

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of: Smith *et al.*

Serial No.: 09/757,073

Filed: 01/08/2001

For: Polyol-Based Method For Forming Thin Film Aerogels On Semiconductor Substrates



Docket: TI-22782B

Examiner: E. Cameron

Art Unit: 1762

RESPONSE TO NOTICE TO FILE CORRECTED PAPERS

Assistant Commissioner for Patents
Washington, DC 20231

MAILING CERTIFICATE UNDER 37 CFR § 1.8
I hereby certify that this correspondence is being deposited with the
United States Postal Service as first class mail in an envelope
addressed to: Assistant Commissioner for Patents, Washington,
DC 20231 on

May 7, 2001

Tina Rendon

Dear Sir:

In response to the "Notice To File Corrected Papers, Filing Date Granted," dated April 11, 2001, please find enclosed the formal drawings for the above-referenced patent application.

Texas Instruments Incorporated
PO Box 655474, M/S 3999
Dallas, TX 75265
(972) 917-4388
Fax: (972) 917-4418

Respectfully Submitted,

David Denker
Attorney for Applicants
Reg. No. 40,987



UNITED STATES PATENT AND TRADEMARK OFFICE

COMMISSIONER FOR PATENTS
UNITED STATES PATENT AND TRADEMARK OFFICE
WASHINGTON, D.C. 20231
www.uspto.gov

APPLICATION NUMBER	FILING/RECEIPT DATE	FIRST NAMED APPLICANT	ATTORNEY DOCKET NUMBER
09/757,073	01/08/2001	Douglas M. Smith	TI-22782B

CONFIRMATION NO. 6613

FORMALITIES LETTER



OC000000005956413

David Denker
Texas Instruments Incorporated
P.O. Box 655474, MS 3999
Dallas, TX 75265



Date Mailed: 04/11/2001

NOTICE TO FILE CORRECTED APPLICATION PAPERS

Filing Date Granted

This application has been accorded an Application Number and Filing Date. The application, however, is informal since it does not comply with the regulations for the reason(s) indicated below. Applicant is given **TWO MONTHS** from the date of this Notice within which to correct the informalities indicated below. Extensions of time may be obtained by filing a petition accompanied by the extension fee under the provisions of 37 CFR 1.136(a)

The required item(s) identified below must be timely submitted to avoid abandonment:

- Substitute drawings in compliance with 37 CFR 1.84 because:
 - drawing sheets do not have the appropriate margin(s) (see 37 CFR 1.84(g)). Each sheet must include a top margin of at least 2.5 cm. (1 inch), a left side margin of at least 2.5 cm. (1 inch), a right side margin of at least 1.5 cm. (5/8 inch), and a bottom margin of at least 1.0 cm. (3/8 inch);
 - Drawings must be reasonably free from erasures and must be free from alterations, overwritings, interlineations, folds, and copy marks.

A copy of this notice MUST be returned with the reply.

Customer Service Center

Initial Patent Examination Division (703) 308-1202

PART 2 - COPY TO BE RETURNED WITH RESPONSE

10-19-01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of: Smith *et al.*

Serial No.: 09/757,073

Filed: 01/08/01

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Examiner: E. Cameron

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LETTER TO THE OFFICIAL DRAFTSPERSON

May 7, 2001

Assistant Commissioner for Patents
Washington, DC 20231

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DC 20231 on

May 7, 2001.
Tina Rendon
Tina Rendon

Draftsperson:

Applicants submit 7 sheet(s) of formal drawings in the above-referenced patent application. These drawings incorporate the changes described in the preliminary amendment filed with the application.

Please charge any required fee to the deposit account of Texas Instruments Incorporated, Account No. 20-0668.

Respectfully submitted,

David Denker
David Denker
Reg. No. 40,987

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